Via kit: Design Verification Report

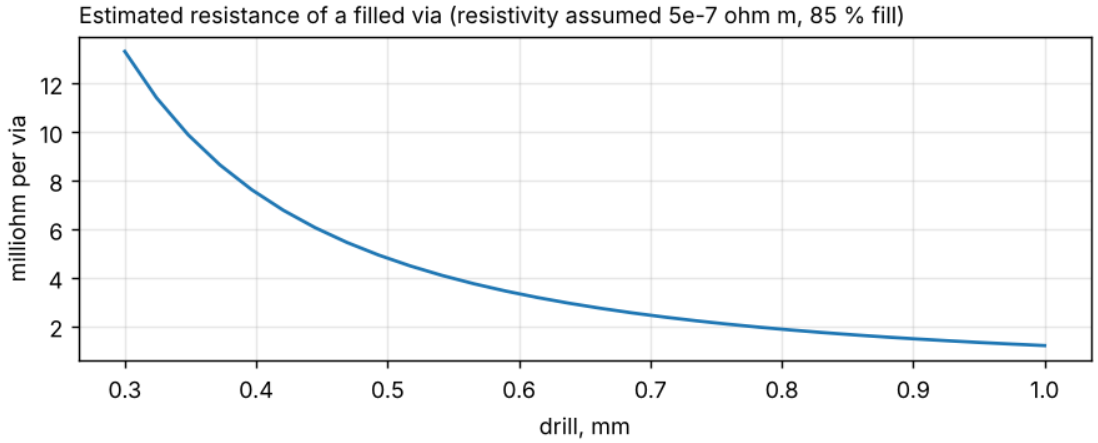
VIA | Blaide product line | 17 November 2026 | Design only: nothing built or tested

What has been checked without hardware, by calculation, simulation or software test.

Results

- The coupon is 22 separate pieces before filling and one circuit after, so one bad via is visible as an open chain
- Estimate 3.3 milliohm per filled 0.6 mm via; whole chain about 70 milliohm plus traces
- Planner selects all 21 coupon holes

Coupon check: 22 separate copper pieces before filling, one circuit after. Planner selects all 21 holes; 10.92 uL of paste in total.



Not verified

Everything in the test plan (document 04) needs hardware.